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ON Semiconductor NTMS4503NR2

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Distributor of ON Semiconductor: Excellent Integrated System Limited Datasheet of NTMS4503NR2 - MOSFET N-CH 28V 9A 8-SOIC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

NTMS4503N

Power MOSFET



Features

- Low R_{DS(on)}
- High Power and Current Handling Capability
- Low Gate Charge
- Pb–Free Package is Available

Applications

- DC/DC Converters
- Motor Drives
- Synchronous Rectifier POL
- Buck Low-Side

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Deting	Ourseland	Value	11
Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V _{DSS}	28	V
Gate-to-Source Voltage - Continuous	V _{GS}	±20	V
Drain Current Continuous @ $T_A = 25^{\circ}C$ (Note 1) Continuous @ $T_A = 25^{\circ}C$ (Note 2) Continuous @ $T_A = 25^{\circ}C$ (Note 3) Single Pulse (tp = 10 μ s)	I _D I _{DM}	14 12 9.0 40	A
Total Power Dissipation $T_A = 25^{\circ}C$ (Note 1) $T_A = 25^{\circ}C$ (Note 2) $T_A = 25^{\circ}C$ (Note 3)	P _D	2.5 1.66 0.93	W
Operating and Storage Temperature	T _J , T _{stg}	–55 to 150	°C
$ \begin{array}{l} \mbox{Single Pulse Drain-to-Source Avalanche} \\ \mbox{Energy} - \mbox{Starting } T_J = 25^\circ\mbox{C} \\ \mbox{(V}_{DD} = 30 \mbox{ V}, \mbox{V}_{GS} = 10 \mbox{ V}, \mbox{I}_L = 12.2 \mbox{ A}, \\ \mbox{L} = 1.0 \mbox{ mH}, \mbox{R}_G = 25 \Omega) \end{array} $	E _{AS}	75	mJ
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	ΤL	260	°C

THERMAL RESISTANCE RATINGS

Rating	Symbol	Value	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2) Junction-to-Ambient (Note 3)	R _{θJA}	50 75 135	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability. 1. Surface-mounted on FR4 board using minimum recommended pad size

1. Surface-mounted on FR4 board using minimum recommended pad size (Cu area 0.412 in sq), t < 10 s.

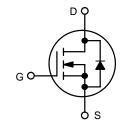
- 2. Surface-mounted on FR4 board using 1" pad size (Cu area 1.127 in sq) steady state.
- Surface-mounted on FR4 board using minimum recommended pad size (Cu area 0.412 in sq), steady state.



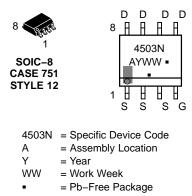
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http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max (Note 1)
28 V	7.0 mΩ @ 10 V	14 A
20 V	8.8 mΩ @ 4.5 V	אדי



MARKING DIAGRAM & PIN ASSIGNMENT



(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping†
NTMS4503NR2	SOIC-8	2500/Tape & Reel
NTMS4503NR2G	SOIC-8 (Pb-Free)	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



NTMS4503N

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-			-	-	-	-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 250 \mu A$		28	31	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	-		-	22	-	mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 24 V	$T_J = 25^{\circ}C$	-	-	1.0	μA
			T _J = 100°C	-	_	25	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} =$	±20 V	-	-	±100	nA
ON CHARACTERISTICS (Note 4)		-			-		
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	1.0	-	2.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J	-		-	-5.0	-	mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D =	: 14 A	-	7.0	8.0	mΩ
		V _{GS} = 4.5 V, I _D =	= 10 A	-	8.8	9.8	
Forward Transconductance	9 FS	V _{DS} = 10 V, I _D =	: 14 A	-	30	-	S
CHARGES, CAPACITANCES AND GATE RE	SISTANCE					•	
Input Capacitance	C _{ISS}			-	2400	-	pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1.0 MHz	, V _{DS} = 16 V	-	1000	-	1
Reverse Transfer Capacitance	C _{RSS}			-	375	-	
Total Gate Charge	Q _{G(TOT)}	-		-	23	-	nC
Threshold Gate Charge	Q _{G(TH)}			-	2.0	-	1
Gate-to-Source Charge	Q _{GS}	V _{GS} = 4.5 V, V _{DS} = 16	V, I _D = 10 A	-	5.0	-	-
Gate-to-Drain Charge	Q _{GD}			-	12	-	
SWITCHING CHARACTERISTICS, $V_{GS} = V$ (Note 5)						
Turn-On Delay Time	t _{d(ON)}			-	18.5	-	ns
Rise Time	tr	$V_{CC} = 45 V V_{DD} = 16$	V In = 10 A	-	70	-	
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 4.5 V, V_{DD} = 16 V, I_{D} = 10 A, R_{G} = 2.0 Ω		-	21	-	
Fall Time	t _f			-	23	-	
DRAIN-SOURCE DIODE CHARACTERISTIC	s						1
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 10 A	$T_J = 25^{\circ}C$	-	0.82	1.2	V
			T _J = 125°C	-	0.65	-	1
Reverse Recovery Time	t _{RR}		1	-	48	-	ns
Charge Time	Ta	$V_{GS} = 0 V,$ $d_{ISD}/d_t = 100 A/\mu s,$ $I_S = 14 A$		-	23	-	
Discharge Time	Tb			-	25	_	
Reverse Recovery Charge	Q _{RR}			-	25	_	nC

4. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

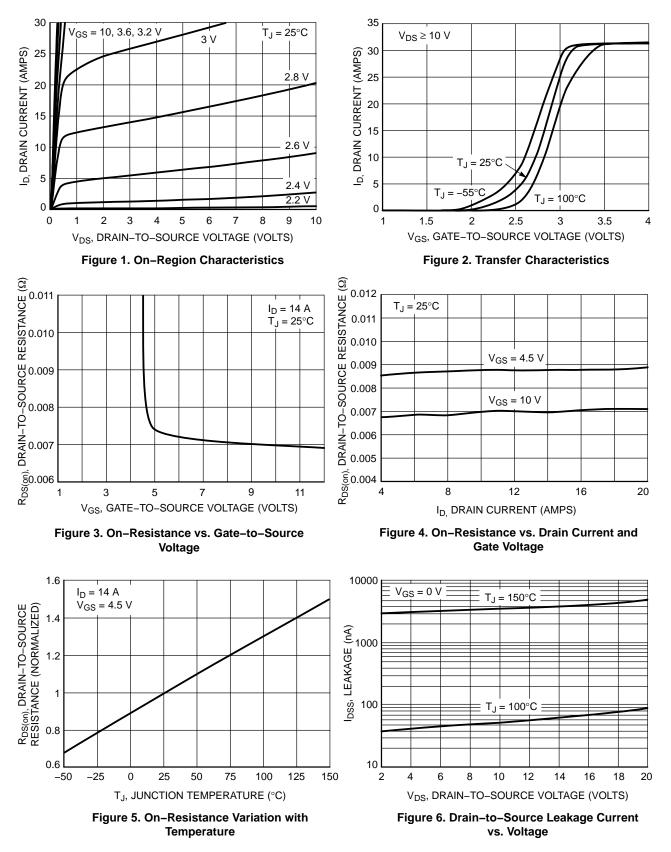
5. Switching characteristics are independent of operating junction temperatures.



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TYPICAL PERFORMANCE CURVES

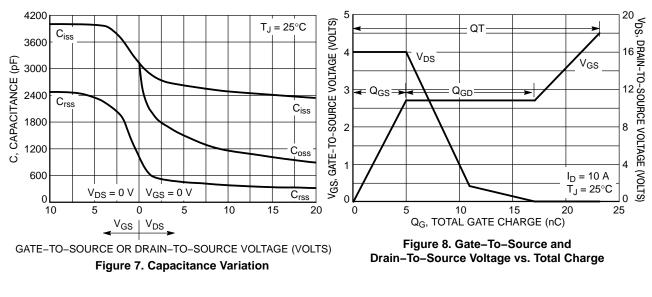


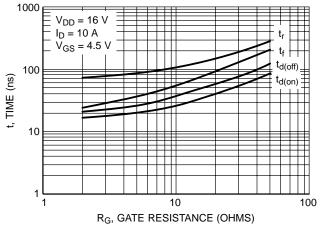


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TYPICAL PERFORMANCE CURVES







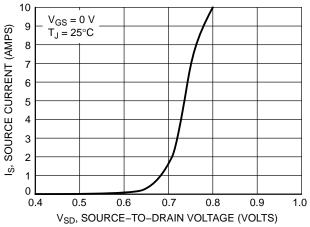
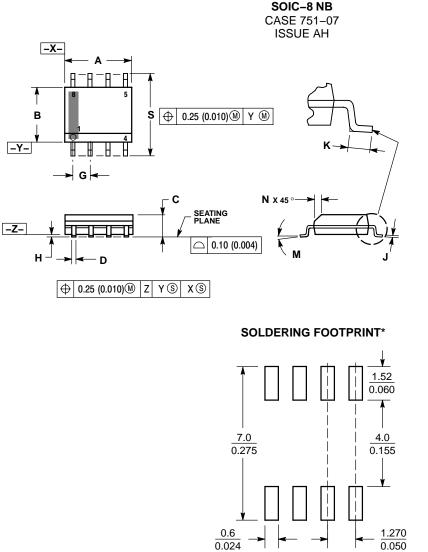


Figure 10. Diode Forward Voltage vs. Current



NTMS4503N

PACKAGE DIMENSIONS



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
- 3.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 (0.006) 4.
- PER SIDE PER SIDE. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION. 751-01 THRU 751-06 ARE OBSOLETE. NEW OTABLE OF 10 THE OF A
- 6
- STANDARD IS 751-07.

	MILLIN	IETERS	INC	HES
DIM	MIN MAX		MIN	MAX
Α	4.80	5.00	0.189	0.197
в	3.80	4.00	0.150	0.157
С	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
Н	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
к	0.40	1.27	0.016	0.050
Μ	0 °	8 °	0 °	8 °
Ν	0.25	0.50	0.010	0.020
s	5.80	6.20	0.228	0.244
STYLE	E 12:			

SOURCE PIN 1.

 $\left(\frac{\text{mm}}{\text{inches}}\right)$

SCALE 6:1

2 SOURCE SOURCE 3. 4 GATE

5.	DRAIN
6.	DRAIN
7	

7. DRAIN 8. DRAIN

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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